

FIG. 1

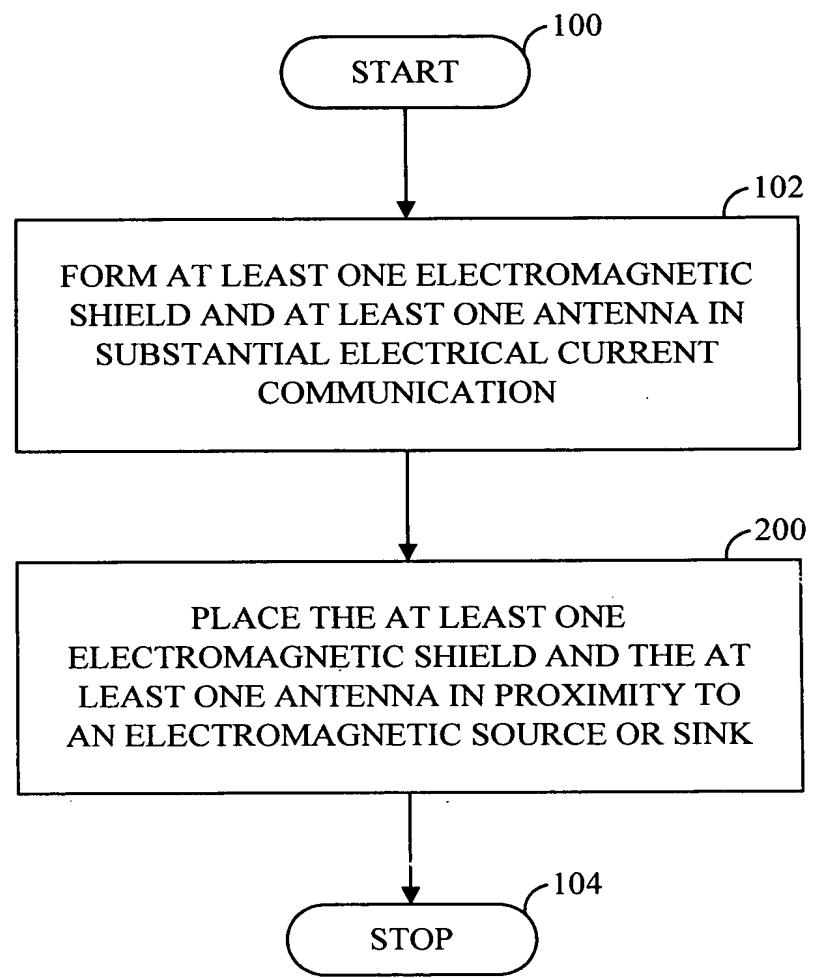


FIG. 2

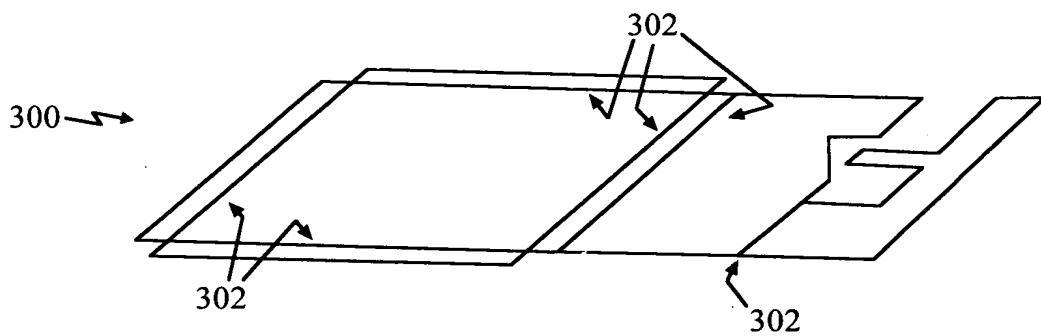


FIG. 3A

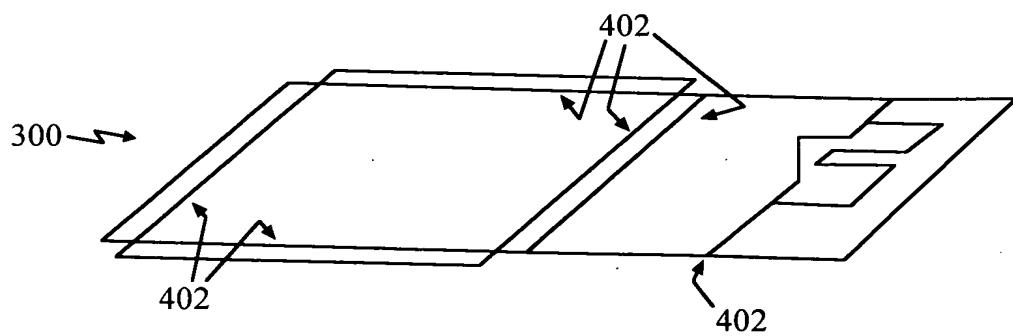


FIG. 4A

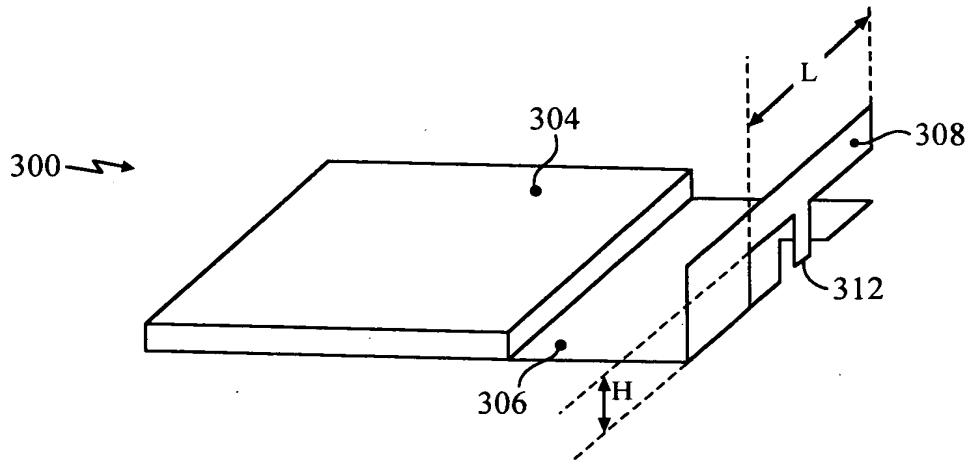


FIG. 3B

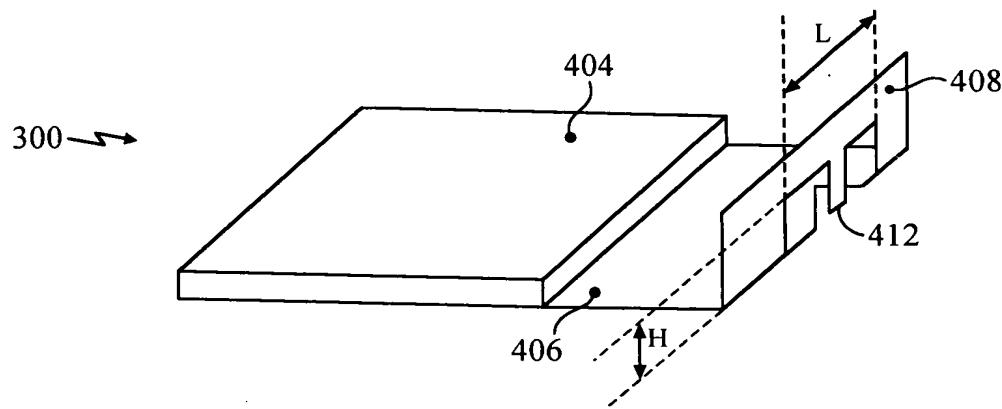


FIG. 4B

FIG. 3C

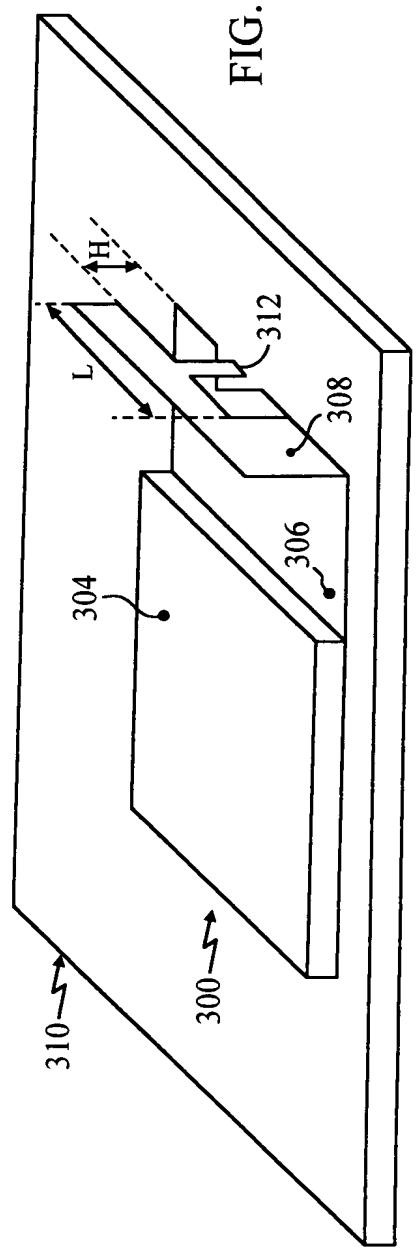


FIG. 4C

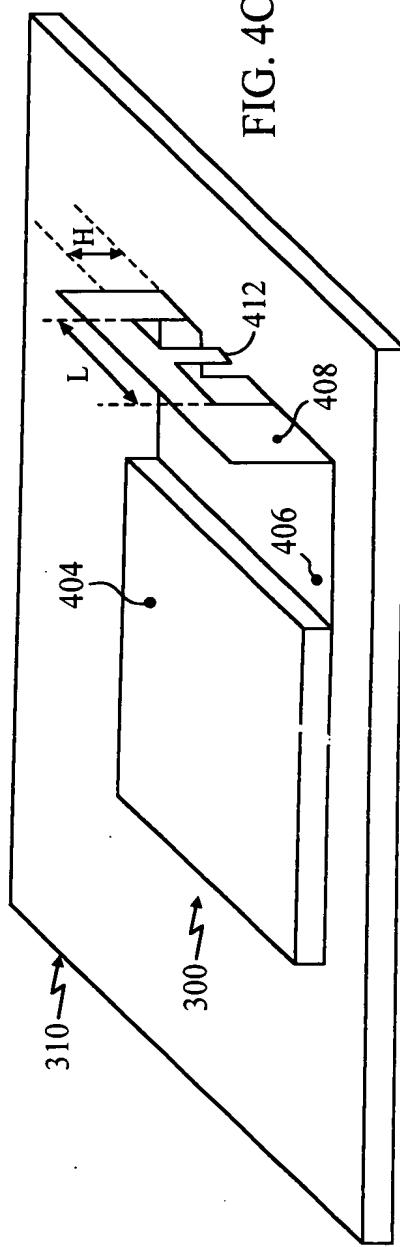


FIG. 5A

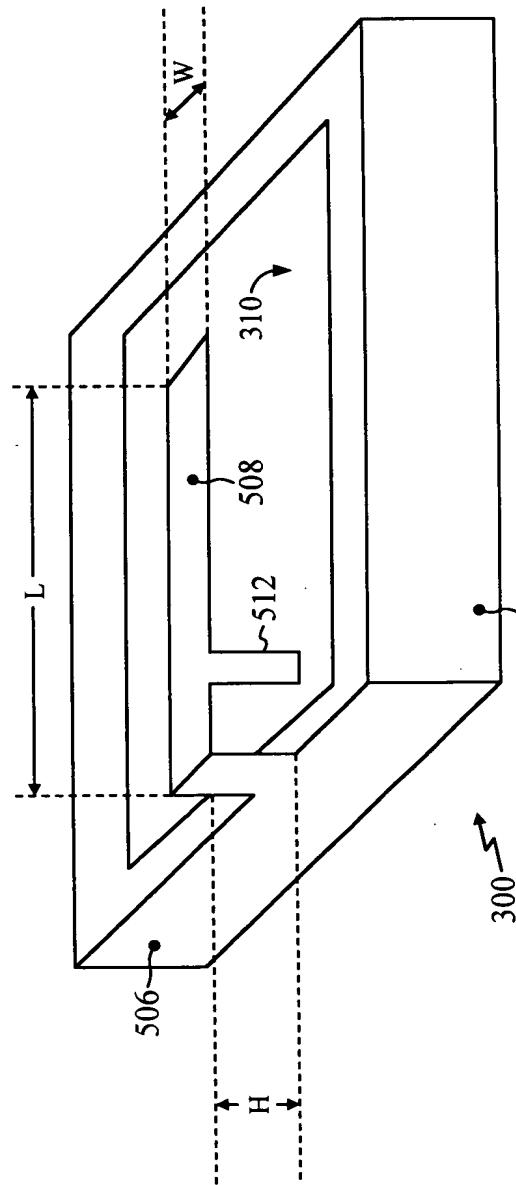
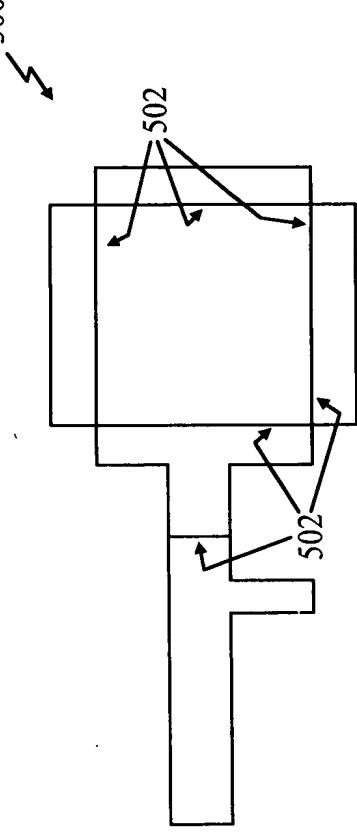


FIG. 5B

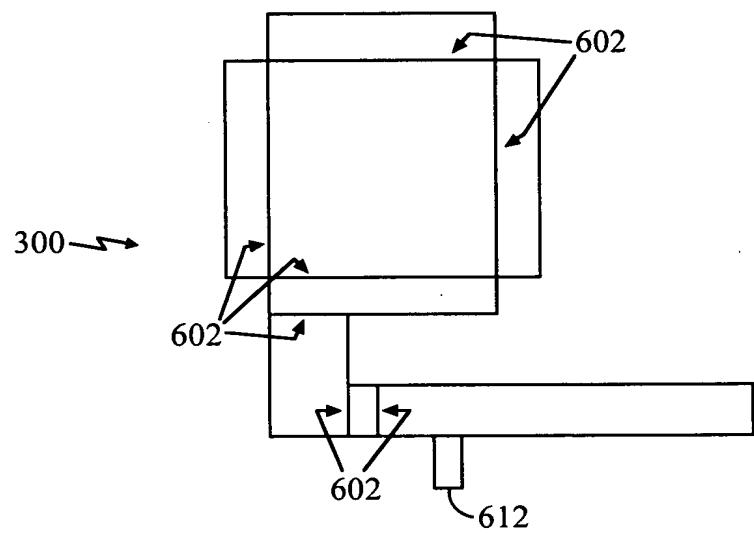


FIG. 6A

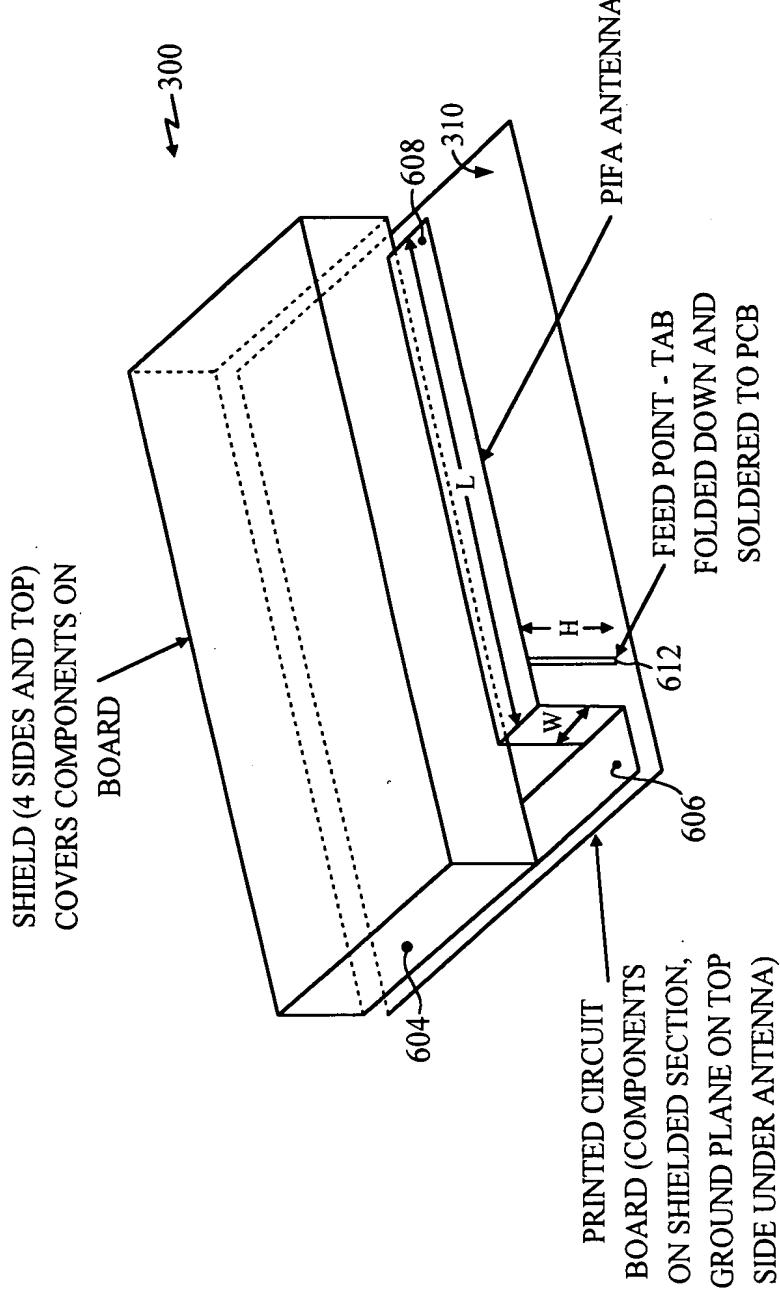
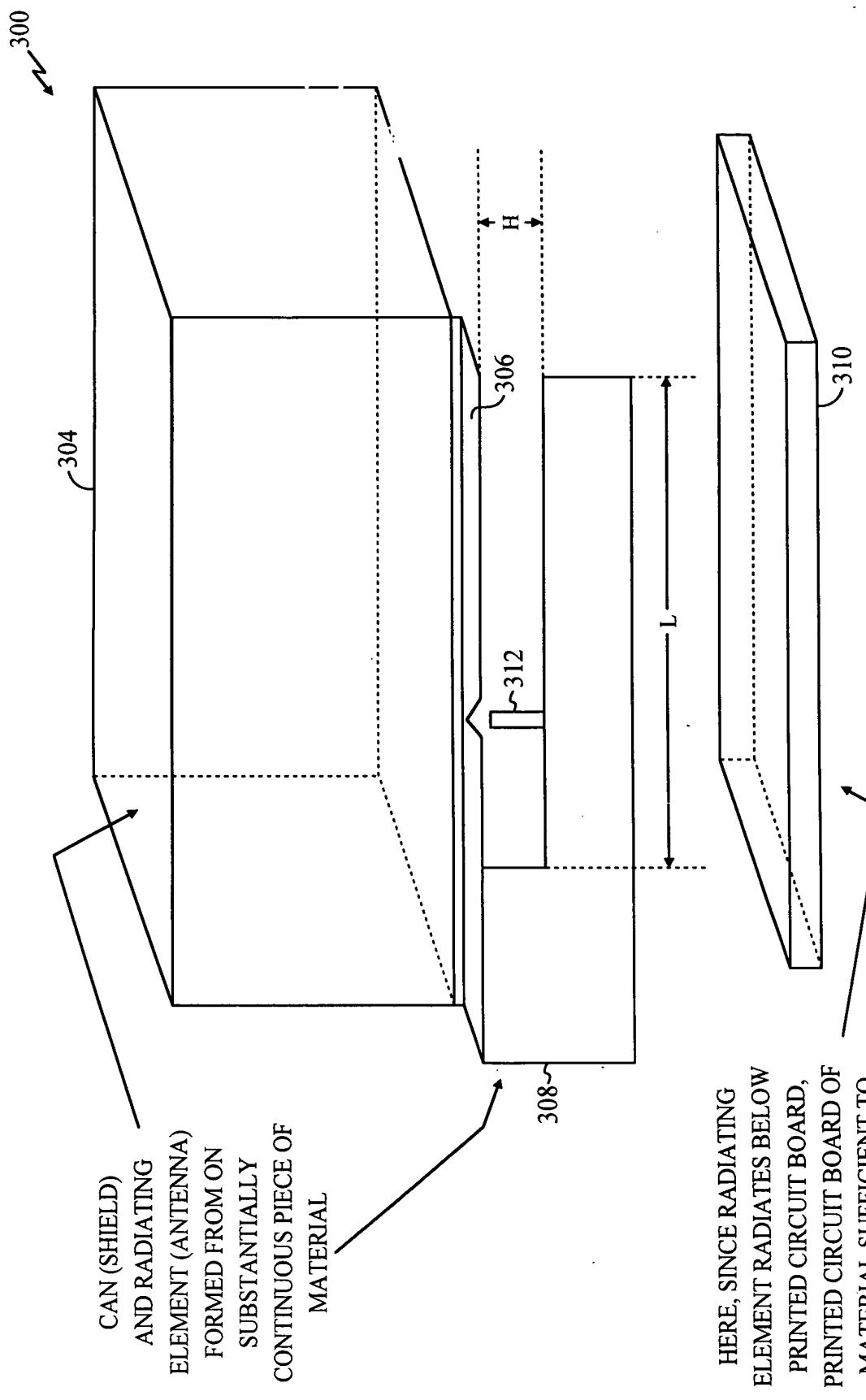


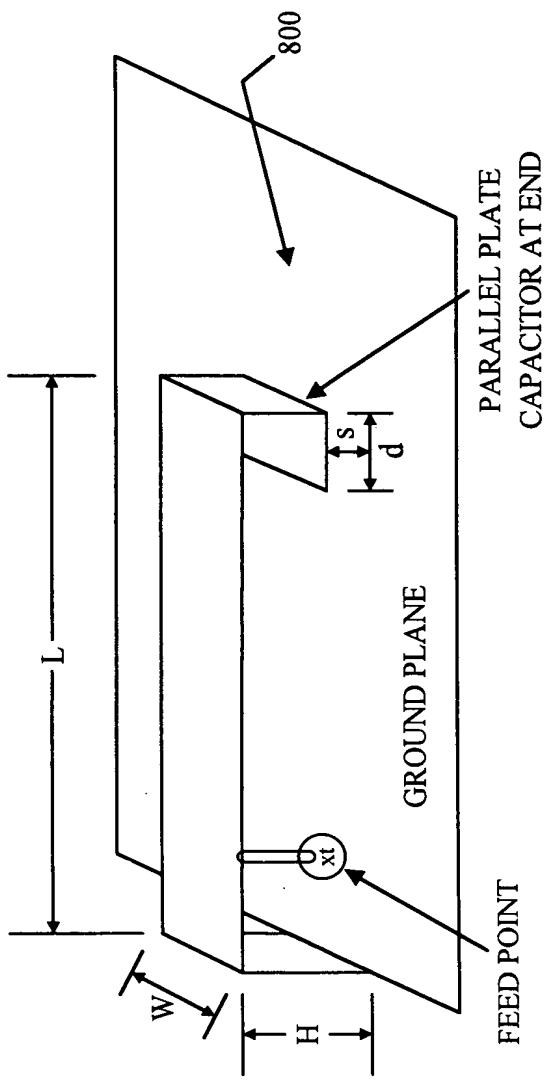
FIG. 6B



HERE, SINCE RADIATING  
ELEMENT RADIATES BELOW  
PRINTED CIRCUIT BOARD,  
PRINTED CIRCUIT BOARD OF  
MATERIAL SUFFICIENT TO  
ACT AS SHIELDING AND/OR  
HAS METAL LAYER

FIG. 7

PIFA WITH INTEGRAL CAPACITOR AT OPEN END



FREQUENCY DETERMINED PRIMARILY BY L AND CAPACITANCE  
CAPACITANCE DETERMINED BY AREA  $W \times d$  AND HEIGHT ABOVE GROUND s  
BANDWIDTH AND EFFICIENCY INFLUENCED BY L, W, AND H

FIG. 8